

Product Summary

| V _{(BR)DSS} | R _{DS(on)} | I _D T _A = +25°C |
|----------------------|-----------------------------|--|
| 60V | $66m\Omega @ V_{GS} = 10V$ | 4.4A |
| | $97m\Omega @ V_{GS} = 4.5V$ | 3.6A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Features and Benefits

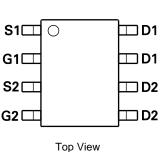
- Low on-resistance
- Fast switching speed
- 100% Unclamped Inductive Switch (UIS) test in production
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

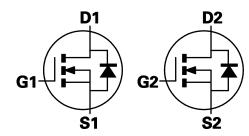
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🔞
- Weight: 0.074 grams (Approximate)



Top View





Equivalent Circuit

Ordering Information (Notes 4 & 5)

| Part Number | Compliance | Case | Packaging |
|----------------|------------|------|-------------------|
| DMN6066SSD-13 | Commercial | SO-8 | 2,500/Tape & Reel |
| DMN6066SSDQ-13 | Automotive | SO-8 | 2,500/Tape & Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

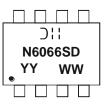
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www. diodes.com/quality/product_grade_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SO-8



⇒ Hanufacturer's Marking
 N6066SD = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 09 = 2009)
 WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic Drain-Source Voltage | | Symbol | Value | Unit | |
|--|----------------|---------------------------------|-----------------|------|----|
| | | V _{DSS} | 60 | V | |
| Gate-Source Voltage | | (Note 6) | V _{GS} | ±20 | V |
| Single Pulsed Avalanche En | ergy | (Note 13) | E _{AS} | 37.5 | mJ |
| Single Pulsed Avalanche Cu | irrent | (Note 13) | I _{AS} | 5.0 | А |
| Continuous Drain Current V _{GS} = 10V | (Note 8) | | 4.4 | | |
| | $V_{GS} = 10V$ | T _A = +70°C (Note 8) | ID | 3.5 | А |
| | (Note 7) | | 3.3 | | |
| Pulsed Drain Current | $V_{GS} = 10V$ | (Note 9) | I _{DM} | 17.0 | А |
| Continuous Source Current | (Body diode) | (Note 8) | ls | 3.2 | А |
| Pulsed Source Current (Bod | y diode) | (Note 9) | I _{SM} | 17.0 | А |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|---|-----------------|------------------|--------------|------------|--|
| Power Dissipation Linear Derating Factor | (Notes 7 & 10) | | 1.25 10 | | |
| | (Notes 7 & 11) | PD | 1.8 14.3 | W mW/°C | |
| | (Notes 8 & 10) | | 2.14 17.2 | | |
| Thermal Resistance, Junction to Ambient | (Notes 7 & 10) | R _{eJA} | 100 | | |
| | (Notes 7 & 11) | | 70 | °C/W | |
| | (Notes 8 & 10) | 0- | 58 | | |
| Thermal Resistance, Junction to Lead | (Notes 10 & 12) | R _{θJL} | 55 | | |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to 150 | °C | |

Notes: 6. AEC-Q101 V_{GS} maximum is $\pm 16V.$

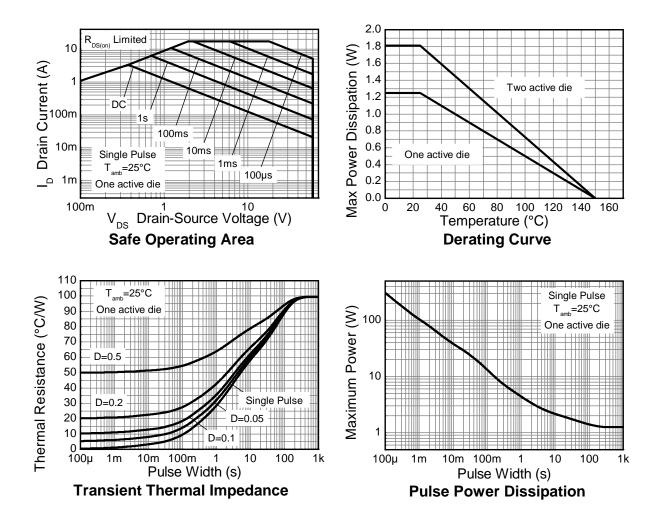
7. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is

The for a device surface mounted on 25mm x 25mm x 15mm FK4 PCB with high coverage of single sided 102 copper, in still all conditions, the device is measured when operating in a steady-state condition. 8. Same as note (3), except the device is measured at t \leq 10 sec. 9. Same as note (3), except the device is pulsed with D = 0.02 and pulse width 300µs. The pulse current is limited by the maximum junction temperature. 10. For a dual device with one active die.

 $\begin{array}{l} \mbox{11. For a device with two active die running at equal power.} \\ \mbox{12. Thermal resistance from junction to solder-point (at the end of the drain lead).} \\ \mbox{13. UIS in production with L = 3.0mH, I_{AS} = 5.0A, R_G = 25\Omega, V_{DD} = 50V, starting T_J = +25^{\circ}C. \end{array}$



Thermal Characteristics





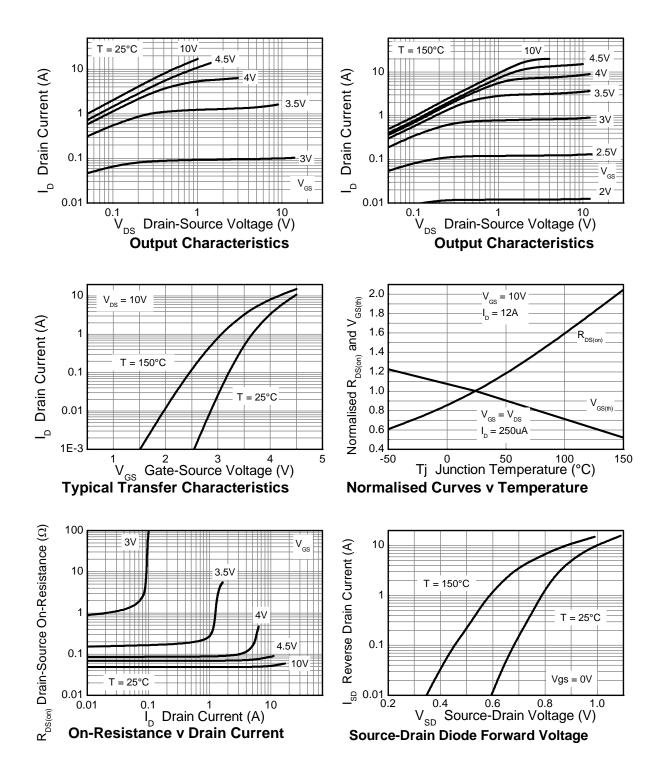
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|--------------------------|-----|-------|-------|------|--|-----------------------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | _ | _ | V | $I_D = 250 \mu A, V_{GS} = 0 V$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 0.5 | μA | V_{DS} = 60V, V_{GS} = | = 0V |
| Gate-Source Leakage | Igss | _ | | ±100 | nA | $V_{GS}=\pm 20V, V_{D}$ | s= 0V |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 1.0 | _ | 3.0 | V | I _D = 250µA, V _{DS} | = V _{GS} |
| Statia Drain Source On Begistenes (Note 14) | | | 0.048 | 0.066 | Ω | V _{GS} = 10V, I _D = 4 | 4.5A |
| Static Drain-Source On-Resistance (Note 14) | R _{DS (ON)} | _ | 0.068 | 0.097 | 12 | V _{GS} = 4.5V, I _D = | 3.5A |
| Forward Transconductance (Notes 14 & 15) | g fs | _ | 19.2 | — | S | V _{DS} = 15V, I _D = 6A | |
| Diode Forward Voltage (Note 14) | V _{SD} | _ | 0.89 | 1.15 | V | I _S = 4.5A, V _{GS} = 0V | |
| Reverse recovery time (Note 15) | t _{rr} | | 22.2 | — | ns | -I _S = 1.9A, di/dt= 100A/µs | |
| Reverse recovery charge (Note 15) | Qrr | _ | 16.9 | _ | nC | | |
| DYNAMIC CHARACTERISTICS (Note 15) | • | | | | | • | |
| Input Capacitance | Ciss | — | 502 | | pF | V _{DS} = 30V, V _{GS} = 0V f= 1MHz | |
| Output Capacitance | C _{oss} | _ | 45.7 | _ | pF | | |
| Reverse Transfer Capacitance | Crss | _ | 27.1 | _ | pF | | |
| Total Gate Charge (Note 16) | Qg | _ | 5.4 | _ | nC | V _{GS} = 4.5V | |
| Total Gate Charge (Note 16) | Qg | _ | 10.3 | _ | nC | V _{DS} = 30V | |
| Gate-Source Charge (Note 16) | Q _{gs} | _ | 1.7 | _ | nC | V _{GS} = 10V | I _D = 4.5A |
| Gate-Drain Charge (Note 16) | Q _{qd} | _ | 3.2 | _ | nC | 1 | |
| Turn-On Delay Time (Note 16) | t _{D(on)} | | 2.7 | | ns | $V_{DD}\text{= }30\text{V}, \text{V}_{GS}\text{= }10\text{V}$ $I_{D}\text{= }1\text{A}, \text{R}_{G}\cong 6.0\Omega$ | |
| Turn-On Rise Time (Note 16) | tr | _ | 2.4 | | ns | | |
| Turn-Off Delay Time (Note 16) | t _{D(off)} | _ | 14.7 | | ns | | |
| Turn-Off Fall Time (Note 16) | t _f | _ | 5.4 | _ | ns | | |

 Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
 For design aid only, not subject to production testing.
 Switching characteristics are independent of operating junction temperatures. Notes:

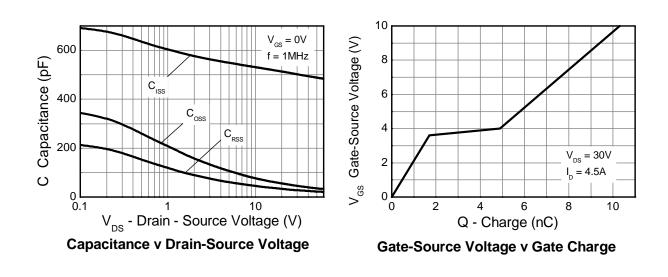


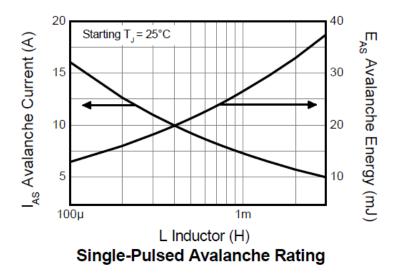
Typical Characteristics



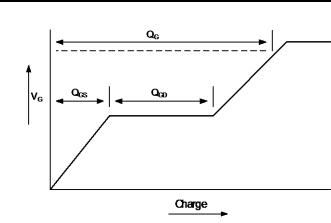


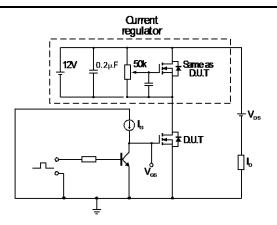
Typical Characteristics (continued)





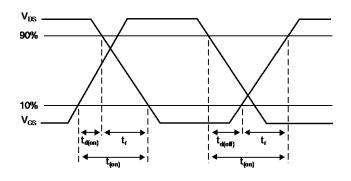




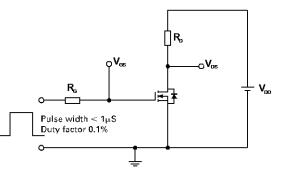


Basic gate charge waveform





Switching time waveforms

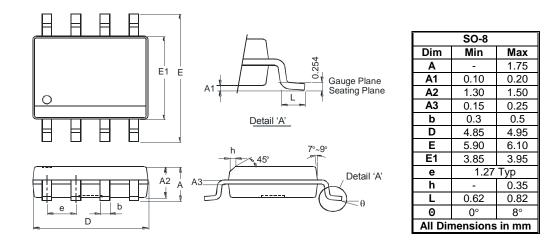


Switching time test circuit



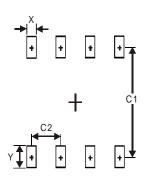
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Y | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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